General Description

The SJV010N850 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

Features

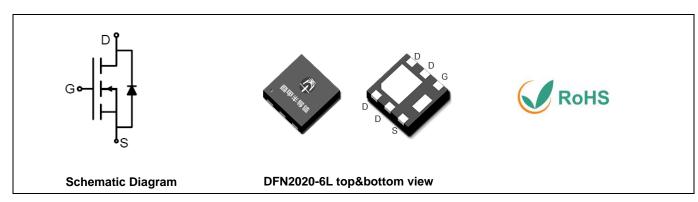
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

Key Performance Parametes

| Parameter | Value | Unit |
|-------------------------|-------|------|
| V _{DS} | 100 | V |
| R _{DS(ON)_TYP} | 87.4 | mΩ |
| ID | 4 | Α |
| Q _G | 20.2 | nC |



Package Marking and Ordering Information

| Device/Ordering Code | Marking | Package | Packing | Reel Size | Tape width | Quantity |
|----------------------|------------|------------|---------|-----------|------------|----------|
| SJV010N850 | SJV010N850 | DFN2020-6L | Tape | \ | / | 3000 Pcs |

Table 1. Absolute Maximum Ratings (T_C=25℃ unless otherwise noted)

| Symbol | Parameter | Limit | Unit |
|--|---|------------|------|
| V _{DS} | Drain-Source Voltage (V _{GS} =0V) | 100 | V |
| Vgs | Gate-Source Voltage (V _{DS} =0V) | ±20 | V |
| 1- | Drain Current-Continuous(T _A =25°C) | 4 | А |
| I _D | Drain Current-Continuous(T _A =100℃) | 2.5 | А |
| I _{DM} (pluse) | Drain Current-Continuous@ Current-Pulsed (Note 1) | 16 | А |
| D | Maximum Power Dissipation(T _A =25°C) | 3.2 | W |
| P _D Maximum Power Dissipation(T _A =100 °C) | | 1.3 | W |
| Eas | Avalanche energy (Note 2) | 25 | mJ |
| TJ, TSTG | Operating Junction and Storage Temperature Range | -55 To 150 | С |

Table 2. Thermal Characteristic

| Symbol | Parameter | Тур | Max | Unit |
|-------------------|---|-----|------|------|
| R ₀ JA | Thermal Resistance, Junction-to-Ambient | | 38.6 | °C/W |



Table 3. Electrical Characteristics (T_J=25℃ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|-----|------|-------|------|
| On/Off States | • | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V I _D =250μA | 100 | | | V |
| | 7 0 1 1/1 5 1 0 1 | V _{DS} =100V, V _{GS} =0V T _J =25°C | | | 1 | μΑ |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =100V, V _{GS} =0V T _J =125℃ | | | 100 | μΑ |
| Igss | Gate-Body Leakage Current | V _{GS} =±20V, V _{DS} =0V | | | ±100 | nA |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250µA | 1 | | 2.5 | V |
| g FS | Forward Transconductance | V _{DS} =5V, I _D =6A | | 6 | | S |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =10V, I _D =6A T _J =25℃ | | 87.4 | 109.3 | mΩ |
| R _{DS(ON)} | Drain-Source On-State Resistance | V _{GS} =4.5V, I _D =4A T _J =25℃ | | 90 | 119.7 | mΩ |
| Dynamic Chara | octeristics | | | · | | I. |
| Ciss | Input Capacitance | | | 951 | | pF |
| Coss | Output Capacitance | V _{DS} =50V,V _{GS} =0V, f=1.0MHz | | 32.3 | | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 27.3 | | pF |
| Rg | Gate resistance | V _{GS} =0V, V _{DS} =0V, f=1.0MHz | | 1.3 | | Ω |
| OSwitching Par | ameters | | | • | • | |
| t _{d(on)} | Turn-on Delay Time | | | 6.6 | | nS |
| t _r | Turn-on Rise Time | V _{GS} =10V, V _{DS} =50V, | | 46 | | nS |
| $t_{d(off)}$ | Turn-Off Delay Time | R _L =8.3 Ω , R _{GEN} =3 Ω | | 31 | | nS |
| t _f | Turn-Off Fall Time | | | 4 | | nS |
| Q_g | Total Gate Charge | | | 20.2 | | nC |
| Qgs | Gate-Source Charge | V _{GS} =10V, V _{DS} =50V, I _D =6A | | 2.1 | | nC |
| Q_{gd} | Gate-Drain Charge | | | 4.2 | | nC |
| Source-Drain D | Piode Characteristics | , | | ı | · | |
| I _{SD} | Source-Drain Current (Body Diode) | | | | 4 | Α |
| V _{SD} | Forward on Voltage (Note 3) | V _{GS} =0V, I _S =6A | | | 1.2 | V |
| t _{rr} | Reverse Recovery Time | I=6A, dI/dt=100A/μs | | 26 | | ns |
| Qrr | Reverse Recovery Charge | I=6A, dI/dt=100A/μs | | 35 | | nC |
| | ı | 1 | | 1 | 1 | |

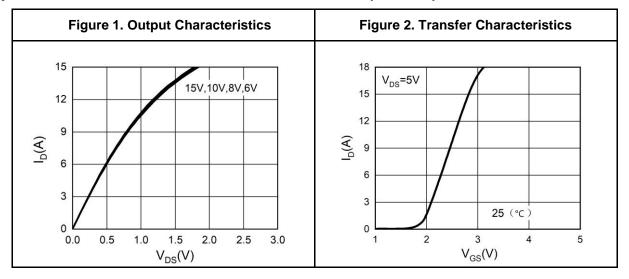
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

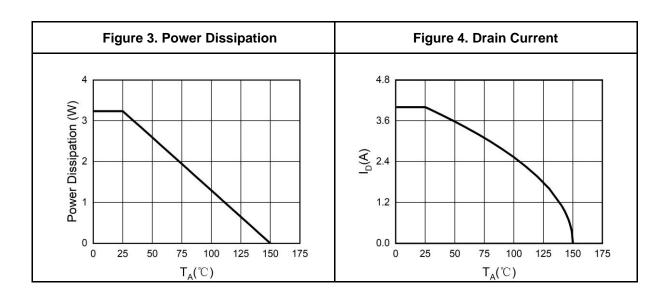
Notes 2.E_{AS} condition: $T_J=25^{\circ}C$, $V_{DD}=40V$, $V_{G}=10V$, $Rg=25\Omega$, L=0.5mH.

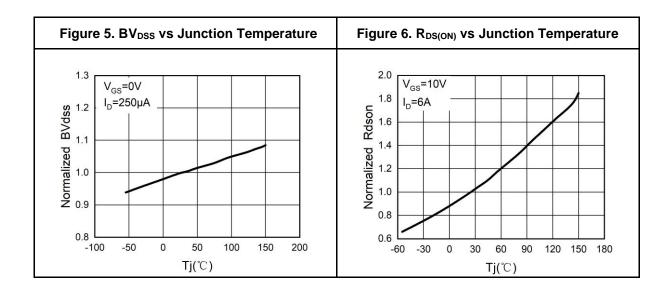
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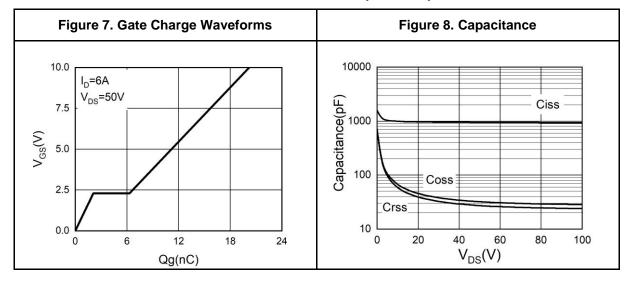
Typical Electrical And Thermal Characteristics (Curves)

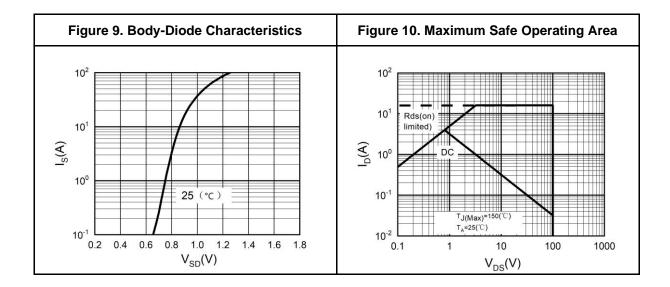




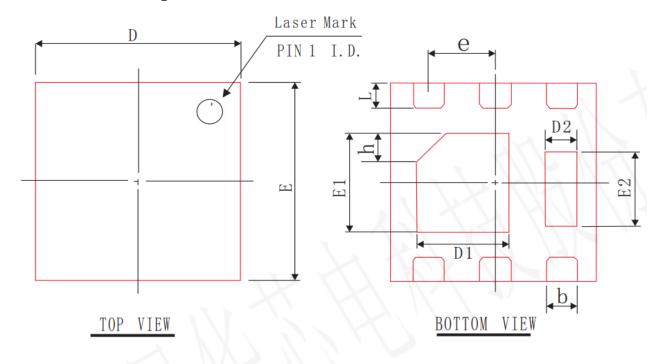


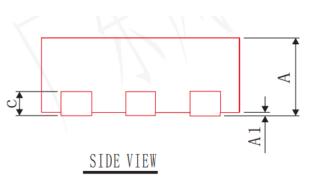
Typical Electrical And Thermal Characteristics (Curves)





DFN2020-6L Package Information





| SYMBOL | MIN | NOM | MAX | | |
|--------|----------|-----------|------|--|--|
| Α | 0.70 | 0.75 | 0.80 | | |
| A 1 | 0.00 | 0.02 | 0.05 | | |
| b | 0.20 | 0.25 | 0.30 | | |
| D | 1.95 | 2.00 | 2.07 | | |
| Е | 1.95 | 2.00 | 2.07 | | |
| D1 | 0.80 | 0.90 | 1.00 | | |
| E1 | 0.90 | 1.00 | 1.10 | | |
| D2 | 0.20 | 0.30 | 0.40 | | |
| E2 | 0.65 | 0.75 | 0.85 | | |
| L | 0.20 | 0.25 | 0.35 | | |
| h | 0.20 | 0.25 | 0.30 | | |
| С | | 0.203 REF | | | |
| е | 0.65 BSC | | | | |

其它厚度尺寸如下

| A | 0.55 | 0.60 | 0.65 |
|---|------|------|------|
| A | 0.50 | 0.55 | 0.60 |



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